

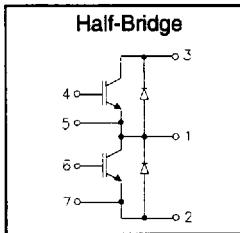


# IRGTIN100M12

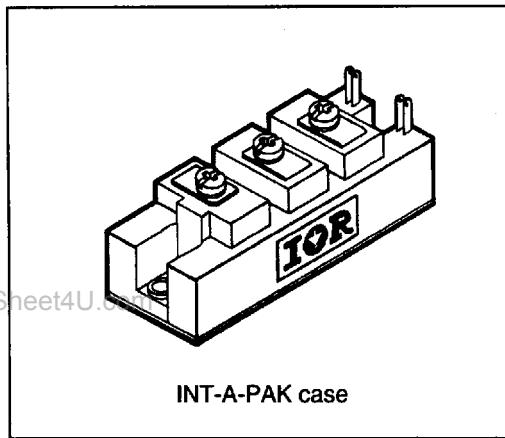
## "HALF-BRIDGE" IGBT INT-A-PAK

## Low conduction loss IGBT

- Rugged Design
- Simple gate-drive
- Switching-Loss Rating includes all "tail" losses
- Short circuit rated



$V_{CE} = 1200V$   
 $I_C = 100A$   
 $V_{CE(ON)} < 2.7V$   
 $t_{sc} > 10\mu s$



## Description

IR's advanced IGBT technology is the key to this line of INT-A-PAK Power Modules. The efficient geometry and unique processing of the IGBT allow higher current densities than comparable bipolar power module transistors, while at the same time requiring the simpler gate-drive of the familiar power MOSFET. These modules are short circuit rated for applications such as motor control requiring this important feature.

## Absolute Maximum Ratings

Parameter	Description	Value	Units
$V_{CES}$	Continuous collector to emitter voltage	1200	V
$I_C @ T_c = 25^\circ C$	Maximum Continuous collector current	175	A
$I_C @ T_c = 85^\circ C$	Maximum Continuous collector current	100	
$I_C @ T_c = 100^\circ C$	Maximum Continuous collector current	75	
$I_{LM}$	Peak IGBT switching current	200	
$I_{FM}$	Peak diode forward switching current (1)	200	
$V_{GE}$	Gate to emitter voltage	$\pm 20$	V
$V_{ISOL}$	RMS isolation voltage, any terminal to case, $t = 1 \text{ min}$	2500	
$P_D @ T_c = 25^\circ C$	Power dissipation	665	
$T_J$	Operating junction temperature range	-40 to 150	°C
$T_{STG}$	Storage temperature range	-40 to 125	

(1) Duration limited by max junction temperature.

**IRGTIN100M12****Electrical Characteristics -  $T_J = 25^\circ C$ , unless otherwise stated**

Parameter	Description	Min	Typ	Max	Units	Test Conditions
$BV_{CES}$	Collector-to-emitter breakdown voltage	1200	—	—	V	$V_{GE} = 0V, I_C = 3mA$
$V_{CE}(ON)$	Collector-to-emitter voltage	—	2.2	2.7		$V_{GE} = 15V, I_C = 100A$
		—	1.8	—		$V_{GE} = 15V, I_C = 80A, T_J = 150^\circ C$
$V_{FM}$	Diode forward voltage - maximum	—	3.2	3.4		$I_F = 100A, V_{GE} = 0V$
		—	2.6	—		$I_F = 100A, V_{GE} = 0V, T_J = 150^\circ C$
$V_{GEth}$	Gate threshold voltage	3.0	—	5.5	mA	$I_C = 1mA$
$\Delta V_{GEth}$	Threshold voltage temp. coefficient	—	-11	—		$V_{CE} = V_{GE}, I_C = 1mA$
$g_{fe}$	Forward transconductance	35	—	70	S(Ω)	$V_{CE} = 25V, I_C = 100A$
$I_{CES}$	Collector-to-emitter leakage current	—	—	3	mA	$V_{GE} = 0V, V_{CE} = 1200V$
		—	—	30		$V_{GE} = 0V, V_{CE} = 1200V, T_J = 150^\circ C$
$I_{GES}$	Gate-to-emitter leakage current	—	—	$\pm 3$	μA	$V_{GE} = \pm 20V$

**Dynamic Characteristics -  $T_J = 125^\circ C$ , unless otherwise stated**

Parameter	Description	Min	Typ	Max	Units	Test Conditions
$E_{on}$	Turn-on switching energy	—	0.19	—	mJ/A	$R_G = 6.8\Omega, V_{CC} = 600V$
$E_{off}$ (1)	Turn-off switching energy	—	0.36	—		$I_C = 100A, L_S = 100nH$
$E_{ts}$ (1)	Total switching energy	—	—	0.60		$V_{GE} = \pm 15V$
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	Turn-on delay time	—	200	250	ns	$R_G = 6.8\Omega, V_{CC} = 600V$
	Rise time	—	200	250		$I_C = 100A$
	Turn-off delay time	—	125	200		$V_{GE} = \pm 15V$
	Fall time	—	650	—		Resistive load, $T_J = 25^\circ C$
$I_{rr}$ $t_{rr}$ $Q_{fr}$	Diode peak recovery current	—	50	—	A	$R_G = 6.8\Omega, V_{CC} = 600V$
	Diode recovery time	—	215	—	ns	$I_C = 100A$
	Diode recovery charge	—	8	—	μC	$V_{GE} = \pm 15V$
$Q_{ge}$ $Q_{gc}$ $Q_g$	Gate-to-emitter charge (turn-on)	65	—	260	nC	$V_{CC} = 600V$
	Gate-to-collector charge (turn-on)	240	—	500		$I_C = 100A$
	Total gate charge (turn-on)	750	—	1350		$V_{GE} = 15V$
$C_{ies}$ $C_{oes}$ $C_{res}$	Input capacitance	15500	—	16500	pF	$V_{GE} = 0V$
	Output capacitance	950	—	1650		$V_{CC} = 30V$
	Reverse transfer capacitance	950	—	1650		f = 1MHz
$t_{sc}$	Short circuit withstand time	10	—	—	μs	$V_{CC} = 720V, V_{GE} = \pm 15V$ Min. $R_G = 6.8\Omega, V_{CEP} = 1000V$

(1) Includes tail losses

**Thermal and Mechanical Characteristics**

Parameter	Description	Typ	Max	Units
$R_{thJC}$ (IGBT)	Thermal resistance, junction to case, each IGBT	—	0.188	°C/W
$R_{thJC}$ (Diode)	Thermal resistance, junction to case, each diode	—	0.209	°C/W
$R_{thCS}$ (Module)	Thermal resistance, case to sink	0.041	0.100	°C/W
Wt	Weight of module	150	—	g

Refer to Section D - page D-17 for Package Outline11 -INT-A-PAK, New -Half Bridge